

L Number	Hits	Search Text	DB	Time stamp
1	2	jp-10229084-\$ did.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/17 10:32
2	3522	257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls. 438/627.ccls. 438/643.ccls. 438/653.ccls.	USPAT; US-PGPUB	2004/05/17 10:36
3	1271	(257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls. 438/627.ccls. 438/643.ccls. 438/653.ccls.) and (copper cu platinum pt) and (platinum pt osmium os ruthenium ru iridium ir rhodium rh)	USPAT; US-PGPUB	2004/05/17 10:37
4	866	(257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls. 438/627.ccls. 438/643.ccls. 438/653.ccls.) and ((copper cu platinum pt) with (platinum pt osmium os ruthenium ru iridium ir rhodium rh))	USPAT; US-PGPUB	2004/05/17 10:37
5	469	((257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls. 438/627.ccls. 438/643.ccls. 438/653.ccls.) and (copper cu platinum pt) and (platinum pt osmium os ruthenium ru iridium ir rhodium rh)) and (electromigrat\$5 void)) and (interconnect\$6 diffusion barrier)	USPAT; US-PGPUB	2004/05/17 10:38
6	1851	((((CU OR COPPER) WITH INTERCON\$10)) AND (DIFFUSION ADJ BARRIER))	USPAT; US-PGPUB	2004/05/17 10:39
7	61	(257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls. 438/627.ccls. 438/643.ccls. 438/653.ccls.) and ((copper cu platinum pt) same (interconnect\$6 diffusion barrier) same (platinum pt osmium os ruthenium ru iridium ir rhodium rh) same (electromigrat\$5 void))	USPAT; US-PGPUB	2004/05/17 10:40
8	470	(257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls. 438/627.ccls. 438/643.ccls. 438/653.ccls.) and (((((CU OR COPPER) WITH INTERCON\$10)) AND (DIFFUSION ADJ BARRIER)))	USPAT; US-PGPUB	2004/05/17 11:22
9	55	((pt OR platinum) WITH INTERCON\$10)) same (diffusion adj barrier)	USPAT; US-PGPUB	2004/05/17 12:12
10	289	((RU OR RUTHENIUM or pt or ir or os or rh or iridium or platinum or osmium or rhodium) same electromigration)	USPAT; US-PGPUB	2004/05/17 12:20
11	210	((RU OR RUTHENIUM or pt or ir or os or rh or iridium or platinum or osmium or rhodium) and electromigration)) and (copper or cu)	EPO; JPO; DERWENT; IBM_TDB	2004/05/17 12:56
12	244	((RU OR RUTHENIUM) and (DIFFUSION ADJ BARRIER))	EPO; JPO; DERWENT; IBM_TDB	2004/05/17 13:34
13	32	((RUTHENIUM or iridium or platinum or osmium or rhodium) and electromigration)	EPO; JPO; DERWENT; IBM_TDB	2004/05/17 13:59
14	478	((257/762.ccls. 257/767.ccls. 257/768.ccls. 257/751.ccls. 438/627.ccls. 438/643.ccls. 438/653.ccls.) and (copper cu platinum pt) and (platinum pt osmium os ruthenium ru iridium ir rhodium rh)) and (electromigrat\$5 void)	USPAT; US-PGPUB	2004/05/17 14:00